

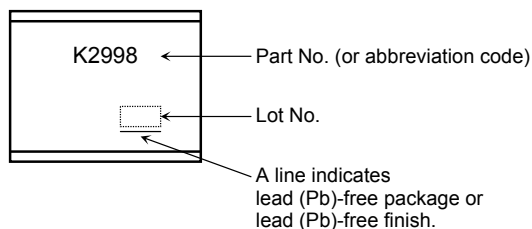
Electrical Characteristics (Ta = 25°C)

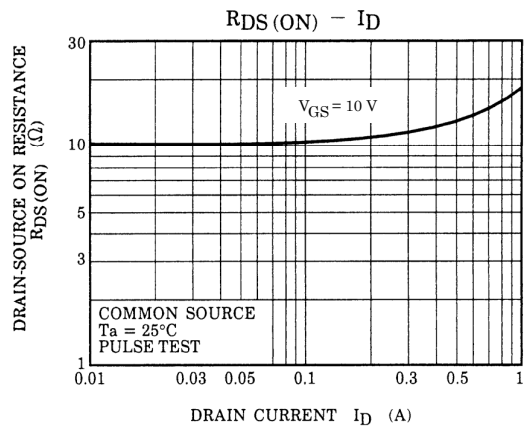
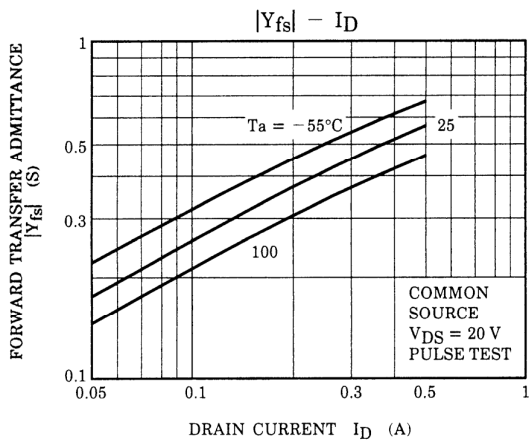
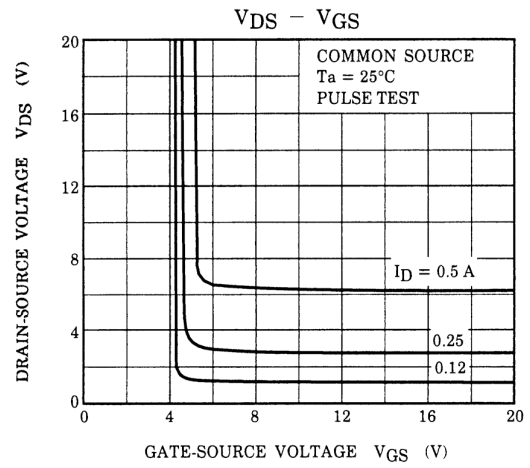
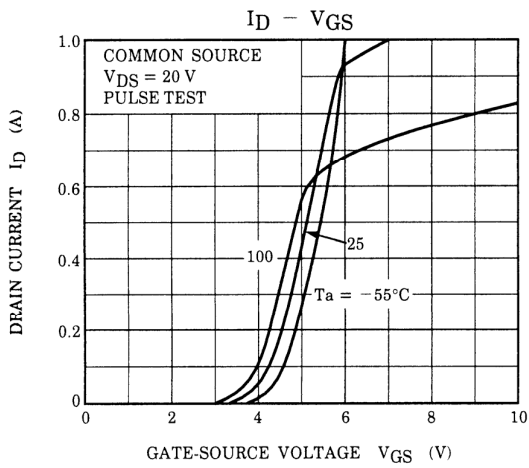
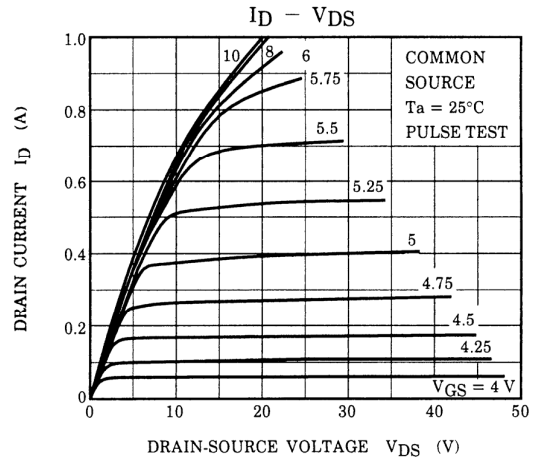
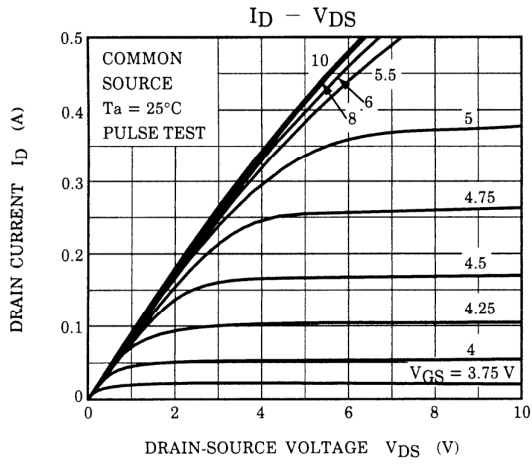
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Gate leakage current	I_{GSS}	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 10	μA	
Gate-source breakdown voltage	$V_{(BR)GSS}$	$I_D = \pm 10\text{ mA}, V_{GS} = 0\text{ V}$	± 30	—	—	V	
Drain cut-off current	I_{DSS}	$V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	μA	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	500	—	—	V	
Gate threshold voltage	V_{th}	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V	
Drain-source ON resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 0.25\text{ A}$	—	11.5	18	Ω	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 0.25\text{ A}$	0.2	0.4	—	S	
Input capacitance	C_{iss}	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	75	—	pF	
Reverse transfer capacitance	C_{rss}		—	7	—		
Output capacitance	C_{oss}		—	25	—		
Switching time	Rise time	t_r		—	11	—	ns
	Turn-on time	t_{on}		—	18	—	
	Fall time	t_f		—	54	—	
	Turn-off time	t_{off}		—	95	—	
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 0.5\text{ A}$	—	3.8	—	nC	
Gate-source charge	Q_{gs}		—	1.9	—		
Gate-drain ("miller") charge	Q_{gd}		—	1.9	—		

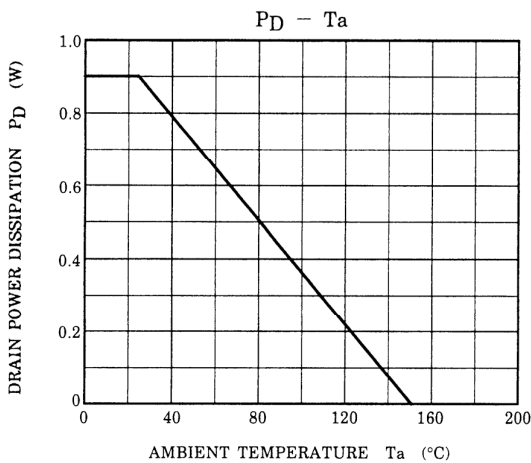
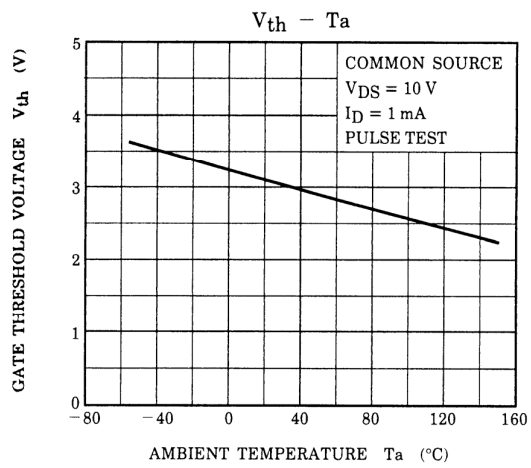
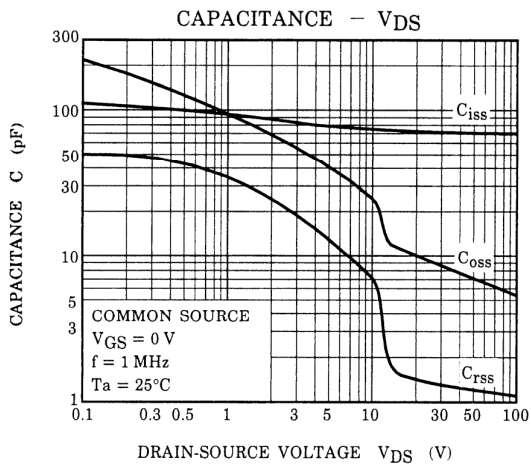
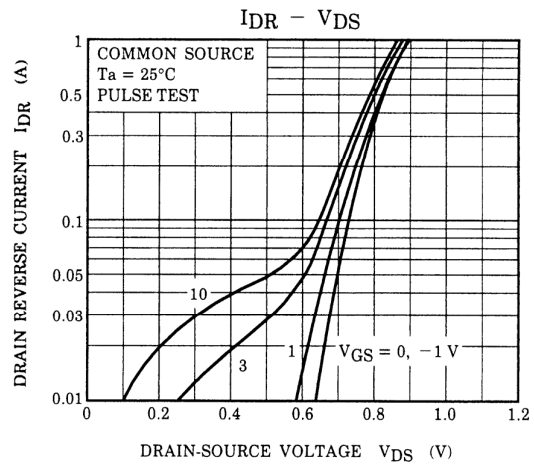
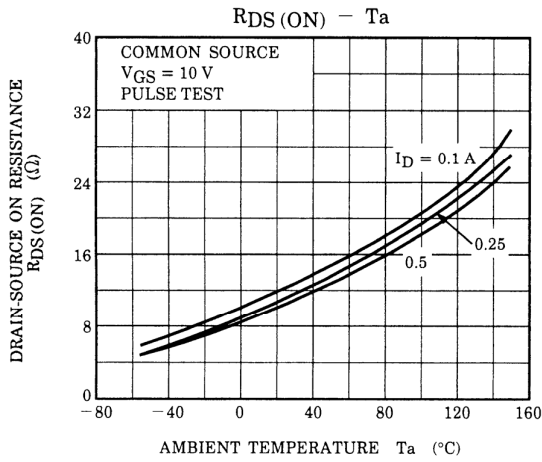
Source-Drain Ratings and Characteristics (Ta = 25°C)

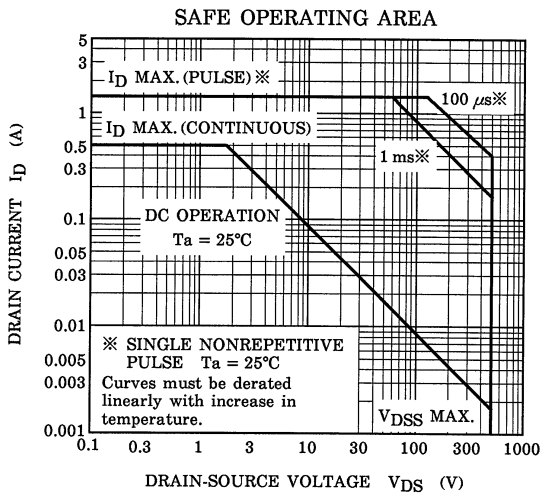
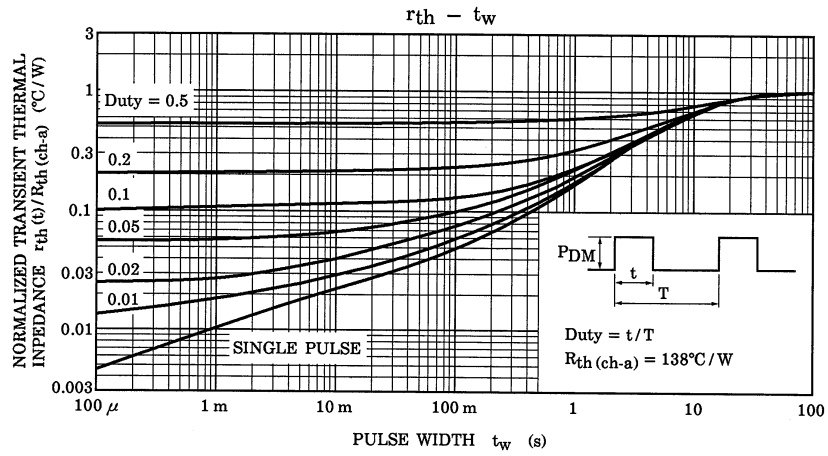
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	0.5	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	1.5	A
Forward voltage (diode)	V_{DSF}	$I_{DR} = 0.5\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	t_{rr}	$I_{DR} = 0.5\text{ A}, V_{GS} = 0\text{ V}$	—	190	—	ns
Reverse recovery charge	Q_{rr}	$dI_{DR} / dt = 100\text{ A} / \mu\text{s}$	—	380	—	nC

Marking









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